

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Neo C. Peng et al.

Title: WAFER DICING DEVICE AND METHOD

Docket No.: 303.772US2
Filed: April 13, 2004
Examiner: Samuel Heinrich
Confirmation No.: 4743

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Group Art Unit: 3742

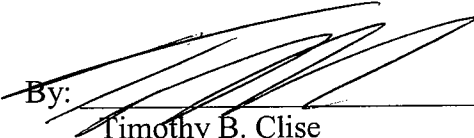
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We are transmitting herewith the following attached items (as indicated with an "X"):

X Amendment and Response under 1.116 (13 pgs.)

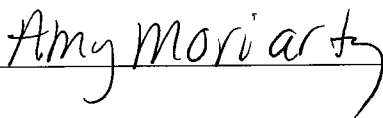
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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being filed using the USPTO's electronic filing system EFS-Web, and is addressed to: Mail Stop AF Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on this 28th day of October, 2008.

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